ASSOCIATION CONNECT	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						als and Mfg	Informati	ion	
upplier Infor	mation														
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
nsemi												2024-05-17			
Contact Name		Title - Contact			F	Phone - Contact*					Email - Contact*				
Product-Env-Stev	wards	Product Enviro Compliance]	NA					Product-Env-Stewards@onsemi.com				
uthorized Repre	sentative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
Reques	ster Item Number						Effective Date	e Version	Version Manufacturing Site		ng Site	W	eight*	UOM	Unit Type
							2024-05-17 PH4		H4		73	73.596 mg		Each	
Ianufacturin ş	g Proccess Informati	ion													
Termina	l Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	-020 MSL Rating		Peak Process Body Temperature		e Max Time at Peak Temper		Temperatur	nture Number of Reflow Cycles		eles
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		lAu) (no	CU Alloy 1		1		260		C 30			seconds	3		
Comments															
vel 1 - maximum	time at peak temperatur	e during so	ldering is 10-3	0 seconds											
or more informa	tion regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	1.25	mg	Supplier	Silicon (Si)	7440-21-3		1.25	mg	
Die Attach	0.136	mg	Supplier	Ethylene glycol dicyclopentenyl ether methacrylate	68586-19-6		0.0048	mg	
			Supplier	Bis(a,a-dimethylbenzyl) Peroxide	80-43-3		0.0009	mg	
			Supplier	Silver (Ag)	7440-22-4		0.1304	mg	
Lead Frame	30.624	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0459	mg	
			Supplier	Silicon (Si)	7440-21-3		0.1991	mg	
			В	Nickel (Ni)	7440-02-0		0.9187	mg	
			Supplier	Copper (Cu)	7440-50-8		29.4603	mg	
Mold Compound-Black	40.867	mg		Epoxy resin	proprietary data		3.8824	mg	
			Supplier	Phenol Resin	Proprietary Data		2.0433	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.2043	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		34.7369	mg	
Plating	0.223	mg	Supplier	Palladium (Pd)	7440-05-3		0.006	mg	
			В	Nickel (Ni)	7440-02-0		0.213	mg	
			Supplier	Gold (Au)	7440-57-5		0.004	mg	
Wire Bond - Au	0.496	mg	Supplier	Gold (Au)	7440-57-5		0.496	mg	